



# X60

**QSS Adhesive**  
**TTS Part No. 159230-10**

## Features

- Designed for strain-gage installation
- Room-temperature cure
- Convenient single-use packaging
- Dilute, easy to spread over QSS bonding surface
- Mixing occurs in sealed poly envelope
- Easy to mix: grasp ends of poly bag, pull apart to force plastic divider off, then pull back and forth over any exposed right-angled corner

## Specifications

- Maximum test temperature: 176°F (80°C)
- Maximum temperature without damage: 302°F (150°C)
- Pot life: 2 to 5 minutes depending on temperature
- Cure time: 20 minutes
- Cure temperature: ambient (no heaters required)
- Total halogens: < 20 ppm
- Shelf life: 1 year
- Packaging: (10) single-use packages per box